



## **50V NPN SMALL SIGNAL TRANSISTOR IN SOT523**

### **Features**

- BV<sub>CEO</sub> > 50V
- I<sub>C</sub> = 150mA High Collector Current
- Ultra-Small Surface Mount Package
- Complementary PNP Type Available (2DA1774Q/R/S)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

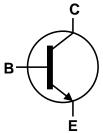
### **Mechanical Data**

- Case: SOT523
- Case Material: Molded Plastic. "Green" Molding Compound.
  UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.002 grams (Approximate)

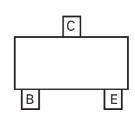
**SOT523** 







Device Symbol



Pin-Out Top View

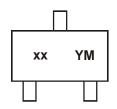
### Ordering Information (Note 4)

Product	Status	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
2DC4617Q-7-F	Active	AEC-Q101	8D	7	8	3000
2DC4617R-7-F	Active	AEC-Q101	8E	7	8	3000
2DC4617S-7-F	Active	AEC-Q101	8F	7	8	3000

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, see http://www.diodes.com/products/packages.html.

## **Marking Information**



 $xx = Product Type Marking Code YM = Date Code Marking Y or <math>\overline{Y} = Year (ex: F = 2018)$  M or  $\overline{M} = Month (ex: 9 = September)$ 

#### Date Code Key

Year	2018	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	F	G	H	ı	J	K	L	М	N	0	Р	Q	R	S
Month	Jan	Feb	Ma	ar .	Apr	May	Jun	Jul	Aug	Se	р	Oct	Nov	Dec
Code	1	2	3	3	4	5	6	7	8	9		0	N	D



# **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	60	V
Collector-Emitter Voltage	V <sub>CEO</sub>	50	V
Emitter-Base Voltage	V <sub>EBO</sub>	7	V
Collector Current—Continuous (Note 5)	I <sub>C</sub>	150	mA

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5) T <sub>A</sub> = 25°C	$P_{D}$	150	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>OJA</sub>	833	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

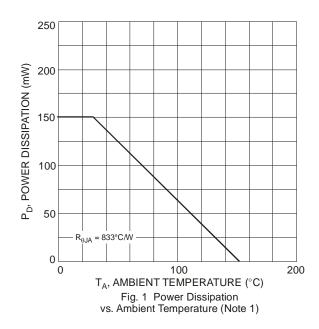
## ESD Ratings (Note 6)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge—Human Body Model	ESD HBM	4000	V	3A
Electrostatic Discharge—Machine Model	ESD MM	400	V	С

Notes:

- 5. For a device mounted with the collector lead, on a minimum recommended pad layout of 1oz copper on a single-sided 1.6mm FR4 PCB. Device is measured under still air conditions whilst operating in a steady-state.
- 6. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

# Thermal Characteristics and Derating Information



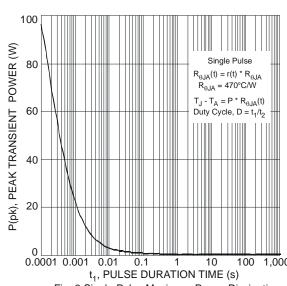
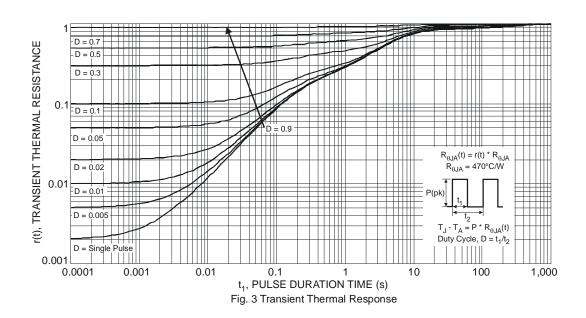


Fig. 2 Single Pulse Maximum Power Dissipation



## Thermal Characteristics and Derating Information (continued)



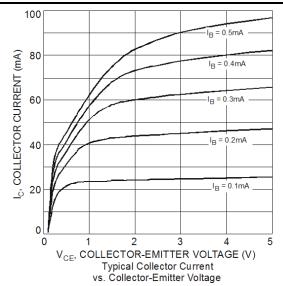
Electrical Characteristics @TA = 25°C unless otherwise specified

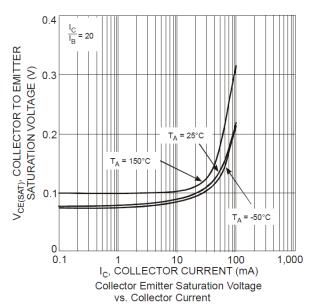
Characteristic		Symbol	Min	Тур.	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)							
Collector-Base Breakdown Voltage		V <sub>(BR)CBO</sub>	60	_	_	V	$I_C = 50\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage		V <sub>(BR)CEO</sub>	50	_		V	$I_C = 1 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage		V <sub>(BR)EBO</sub>	7	_	_	V	$I_E = 50\mu A, I_C = 0$
Collector Cutoff Current		I <sub>CBO</sub>	_	_	100	nA	V <sub>CB</sub> = 60V
Emitter Cutoff Current		I <sub>EBO</sub>	_	_	100	nA	$V_{EB} = 6V$
ON CHARACTERISTICS (Note 7)							
DC Current Gain	2DC4617Q 2DC4617R 2DC4617S	h <sub>FE</sub>	120 180 270		270 390 560	_	V <sub>CE</sub> = 6V, I <sub>C</sub> = 1mA
Collector-Emitter Saturation Voltage		V <sub>CE(SAT)</sub>	_	_	0.4	V	I <sub>C</sub> = 50mA, I <sub>B</sub> = 5mA
SMALL SIGNAL CHARACTERISTICS		. ,	•				
Output Capacitance		C <sub>obo</sub>	_	2	3.5	pF	$V_{CB} = 12V, f = 1MHz, I_E = 0$
Current Gain-Bandwidth Product		f <sub>T</sub>	_	140		MHz	$V_{CE} = 12V$ , $I_C = 2mA$ , $f = 1MHz$
Current Gain-Bandwidth Product		f <sub>T</sub>	_	180	_	MHz	V <sub>CE</sub> = 12V, I <sub>C</sub> = 0mA, f = 1MHz
Current Gain-Bandwidth Product		f⊤	_	180	_	MHz	V <sub>CE</sub> = 12V, I <sub>C</sub> = 2mA, f = 100MHz

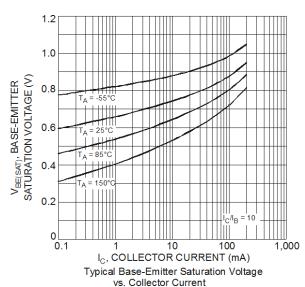
Notes: 7. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$  2%.

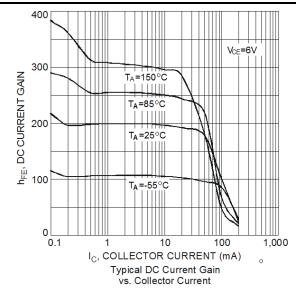


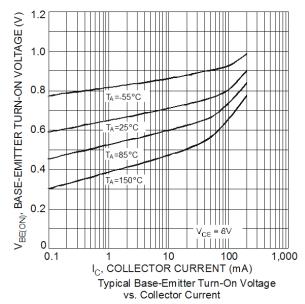
# Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)









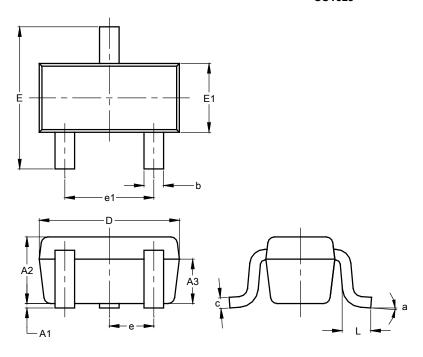




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT523**

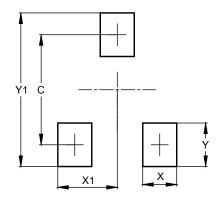


SOT523							
Dim	Min	Max	Тур				
<b>A</b> 1	0.00	0.10	0.05				
A2	0.60	0.80	0.75				
A3	0.45	0.65	0.50				
b	0.15	0.30	0.22				
С	0.10	0.20	0.12				
D	1.50	1.70	1.60				
Е	1.45	1.75	1.60				
E1	0.75	0.85	0.80				
е		0.50 BS	С				
e1	0.90	1.10	1.00				
L	0.20	0.40	0.33				
а	0°		8°				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT523



Dimensions	Value			
Dimensions	(in mm)			
С	1.29			
Х	0.40			
X1	0.70			
Y	0.51			
Y1	1.80			



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